Notes:
1) Build on PMP7451 Rev A PCB.
2) Reference designators >99 were added for PMP8366.

Lower Cost Alternative for T2 : Pulse PH2006.005CNL

Texas Instruments

Title
36-75Vin, 5V/20A, Active Clamp Forward

Sheet 1 of 1

PMP8366

B KING

3/4/2013
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